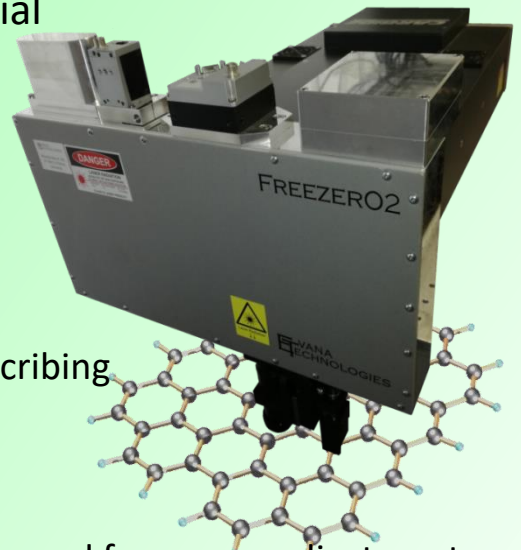


EVANA TECHNOLOGIES

Technologies and tools for:

- Scribing silicon carbide and other material wafers for microelectronics industry

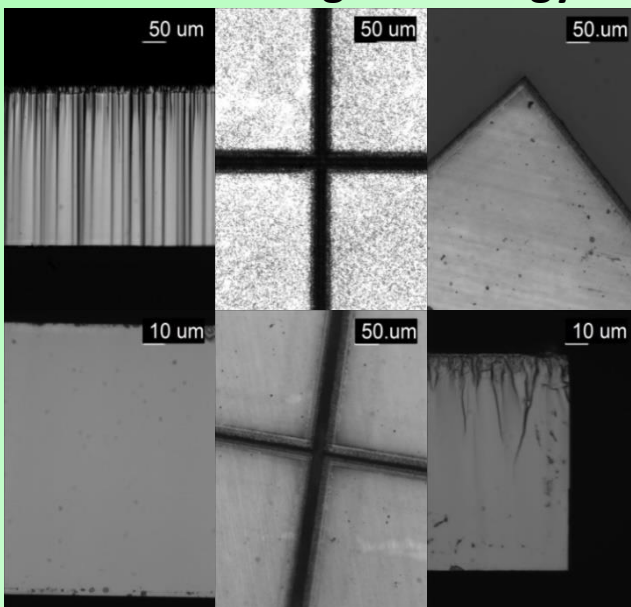


Products: Freezer series optical engines

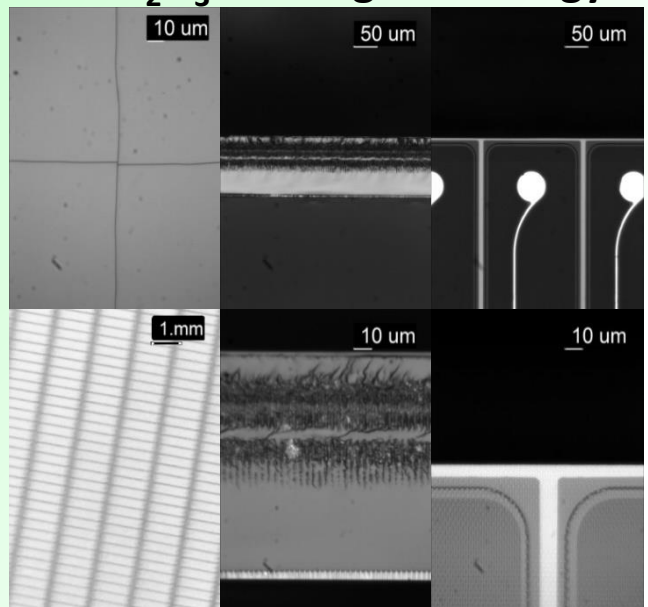
Features:

- Optical systems for different material wafer scribing
- Built-in vertical focal point adjustment
- Built-in sample visualization system
- Highly stable and reliable design
- High versatility – optical power, pulse duration and frequency adjustments.

SiC scribing technology



Al₂O₃ scribing technology



- Easy breaking
- High accuracy
- Uncoated samples
- Wafer thickness above 330 μm
- High throughput
- Gold coated SiC scribing
- Scribing speed above 300 mm/s
- No chipping
- DBR coated Al₂O₃ scribing

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